

RELIABILITY TEST REPORT

TESTITEM: 1.ELECTRICAL 2.MECHANICAL 3.ENVIRONMENTAL

SERIES NO.: CI52 Series

TEST EQUIPMENT: 1.INSERTION & REMOVAL APPARATUS 2.ELECTRONIC MEASURING APPARATUS 3.ENVIRONMENTAL APPARATUS

DATE OF TESTING: 3 / 12 / 03

TEST DEPART: QA

TESTER: Chro

CONTAINT: ATTACHED

REVIEWED : APPROVED : THE VERIFIED : CLARGE



1.ELECTRICAL PERFORMANCE :

	ITEM	TEST CONDITION	REQUIREMENT	TE	ST RESULT
1-1	Contact resistance	Dry circuit of DC 20mV	Less than 20 m Ω	Sample	$20 \text{ m}\Omega$ max.
		max.100mA max.		1	1.60 mΩ
				2	1.74 mΩ
				3	1.67 mΩ
				4	1.68 mΩ
				5	1.70 mΩ
1-2	Dielectric strength	When applied AC 1500V 1	No change	Sample	1500 V 1 minute
	C	minute between adjacent	U	1	Pass
		terminal		2	Pass
				3	Pass
				4	Pass
				5	Pass
1-3	Insulation resistance	When applied DC 500 V	More than 1000 M Ω	Sample	1000 MΩ min.
		between adjacent terminal		1	$20 \times 10^5 \mathrm{M}\Omega$
		or ground		2	$20 \times 10^5 \mathrm{M}\Omega$
				3	$15 \times 10^5 \mathrm{M}\Omega$
				4	$20 \times 10^5 \mathrm{M}\Omega$
				5	$15 \times 10^5 \mathrm{M}\Omega$

2. MECHANICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT	TE	ST RESULT
2-1	Terminal crimp tensile	When crimped AWG# 16 size	More than 11.0 Kgf	Sample	>11.0 Kgf
	strength	wire		1	13.45 Kgf
				2	13.47 Kgf
				3	13.87 Kgf
				4	13.58 Kgf
				5	14.02 Kgf
		When crimped AWG# 18	More than 9.0 Kgf	Sample	> 9.0 Kgf
		size wire		1	11.24 Kgf
				2	10.97 Kgf
				3	10.45 Kgf
				4	11.04 Kgf
				5	10.57 Kgf
		When crimped AWG# 20	More than 7.0 Kgf	Sample	> 7.0 Kgf
		size wire		1	7.98 Kgf
				2	7.14 Kgf
				3	7.87 Kgf
				4	7.38 Kgf
				5	7.18 Kgf



		When arimoned AWC# 22	More than 5.0 K of	Sample	> 5 0 K of
			Mole mail 5.0 Kgi	1	5.98 Kof
		size wire		2	6.23 Kgf
				3	6.35 Kgf
				4	5.89 Kgf
				5	6.45 Kgf
2_2	Terminal insertion	Insertion speed 25+ 3 mm	Less than 1.5 K of	Sample	< 1.5 Kgf
	forma	nor minute into housing		1	0.78 Kgf
	loice	per minute into nousing		2	0.70 Kgf
				3	0.76 Kgf
				4	0.75 Kgf
				5	0.71 Kgf
2-3	Contact retaining force	Retention speed $25 \pm 3 \text{ mm}$	More than 3.0 Kgf	Sample	> 3.0 Kgf
	in insulator	per minute from housing		1	7.31 Kgf
				2	7.67 Kgf
				3	6.87 Kgf
				4	7.23 Kgf
				5	7.10 Kgf
2-4	Single contact	Measure force to insertion	1.2 Kgf max.	Sample	1.2 Kgf max.
	insertion force	using 1.14 mm square pin at	6	1	0.62 Kgf
		speed 25±3 mm per minute		2	0.65 Kgf
				3	0.72 Kgf
				4	0.69 Kgf
				5	0.67 Kgf
2-5	Single contact	Measure force to withdrawal	300 gram min.	Sample	300 gram min.
	withdrawal force	using 1.14 mm square pin at		1	571 gram
		speed 25±3 mm per minute		2	510 gram
				3	594 gram
				4	542 gram
				5	526 gram
2-6	Durability	Connector shall be subjected	Contact resistance:	Sample	< twice of initial
		to100 cycles of	Less than twice of	1	$1.68 \text{ m}\Omega$
		insertion and withdrawal	initial	2	1.76 mΩ
				3	1.69 mΩ
				4	1.76 mΩ
				5	1.76 mΩ
2-7	Pin retention force	Push pin from insulator base	More than 2.5 Kgf	Sample	> 2.5 Kgf
		at speed 25±3mm per minute		1	4.06 Kgf
				2	4.44 Kgf
				3	4.27 Kgf
				4	3.98 Kgf
				5	4.47 Kgf



2-8	Mating and unmating	Speed 25±3 mm per minute	2 pin	Unit: Kgf	Sample	Mating	unmating
_	force		Mating for	orce 2.5	1	1.78	1.26
			max.	Unmating	2	1.64	1.48
			torce		3	1.83	1.32
			0.3 шш.		4	1.72	1.37
					5	1.86	1.42
			6 pin	Mating	Sample	Mating	unmating
			force	5.0 max.	1	4.13	3.77
			Unmating	force	2	3.79	3.96
			0.7 min.		3	4.20	3.85
					4	3.87	3.42
					5	4.08	3.57
			12 pin		Sample	Mating	unmating
			Mating fo	orce	1	9.27	5.48
			11.5 max		2	10.25	6.50
			Unmating	torce	3	9.79	5.62
			2.0 min.		4	10.10	5.94
					5	9.71	6.22

3. ENVIRONMENTAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT	TE	ST RESULT
3-1	Temperature rise	Then carried the rated current	30 max.	Sample	30 max.
3-2	Vibration	ration 1.5 mm 10-55-10 HZ/minute A each 2 hours for X, Y and Z directions I	Appearance: No damage	Sample	No damage
			Discontinuity: 1 micro second max.	Sample	1 micro second max.
3-3	Solder ability Soldering time: 5 ±0.5 sec. Minimum: Soldering pot:230 ±5 90% of immersed are	Minimum:	Sample	90% of Immersed area	
		Soldering pot:230 ±5 90% of immersed at	90% of immersed area	1	Pass
				2	Pass
				3	Pass
				4	Pass
				5	Pass
3-4	Resistance to soldering	Soldering time: 5 \pm 0.5 sec.	No damage	Sample	No damage
	heat	at Soldering pot:260 ±5		1	Pass
				2	Pass
				3	Pass
				4	Pass
				5	Pass



3-5	Heat aging	85 £ 96 hours	No damage	Sample	No damage
55	i icat aging	05 <u>2</u> , 90 hours	110 damage	1	Pass
				2	Pass
				3	Pass
				4	Pass
				5	Pass
3-6	Humidity	40 £ ,90-95%RH,96	Appearance:	Sample	No damage
		hours measurement must be	No damage	1	Pass
		taken within 30 min. after	C C	2	Pass
		tested		3	Pass
				4	Pass
				5	Pass
			Contact resistance:	Sample	< twice of initial
			Less than twice of	1	$1.65 \text{ m}\Omega$
			initial	2	$1.70 \text{ m}\Omega$
				3	$1.75 \text{ m}\Omega$
				4	$1.72 \text{ m}\Omega$
				5	1.67 mΩ
			Dielectric strength:	Sample	Pass para 1-2
			To pass Para 1-2	1	Pass
				2	Pass
				3	Pass
				4	Pass
				5	Pass
3-7	Temperature cycling	One cycle consists of:	Appearance: No	Sample	No damage
		1. -55^{+0}_{-3} , 30 min	damage	1	Pass
		2. Room temp. 10-15 min		2	Pass
		3.85^{+3} 30 min		3	Pass
		3.03^{-0} , 30 mm		4	Pass
		4. Room temp. 10-15 min		5	Pass
			Contact resistance:	Sample	< twice of initial
			Less than twice of	1	$1.66 \text{ m}\Omega$
			initial	2	1.68 mΩ
				3	1.70 mΩ
				4	1.72 mΩ
				5	1.71 mΩ
3-8	Salt spray	Temperature:35±3°C	Appearance:	Sample	No damage
		Solution:5±1%	No damage	1	Pass
		Spray time:48±4hours	6	2	Pass
		Measurement must be taken		3	Pass
		after water rinse		4	Pass
				5	Pass



Contact resistance:	Sample	< twice of initial
Less than twice of	1	$1.69 \text{ m}\Omega$
initial	2	$1.75 \text{ m}\Omega$
	3	$1.72 \text{ m}\Omega$
	4	$1.70 \text{ m}\Omega$
	5	1.73 mΩ